

APPROVAL SHEET

|--|

CUSTOMER:

CUSTOMER'S APPROVAL:

AUTHORIZED SIGNATURE/STAMP:

DATE

MANUFACTURER:	
HEAD OFFICE:	
	13F.,No.120-10,Sec.3,Zhongshan Rd.,Zhonghe Dist.,New Taipei City 23544,Taiwan Tel: 886-2-8221-2567
	Fax:882-2-2225-7268
	E-mail:service@chipfast.com.tw
China Branch:	
	Factory Building B)Shuangpeng,Weibu Village, Qiuchang Town,
	Huiyang District, Huizhou City, Guangdong Province, P.R.C.)
	Tel: 86-752-3562001
	Fax:86-752-3558696
	E-mail:service@atpptc.com

Submitted by:	Chung Cheng
Approved by:	YC Lin
DATE:	2-Mar-22

SEA & LAND ELECTRONIC CORP.

as chan ag chac chan

Features

Surface Mount Devices

- I ead free device
- Size 3.2*2.5mm/0.12*0.10 inch
- Surface Mount packaging for automated assembly

Computer mother board, Modem. Telecommunication equipments.

Almost anywhere there is a low voltage

power supply, up to 30V and a load to be

Applications

protected, including:

Alpha-Top (Sea&Land Alliance)

4

SMD1210-010-60V

Performance Specification												
Model	Maximum del Marking V _{max} I _{max} I _{hold} I _{trip} P _d Time To Trip Descent Descent Descent Provide The Total Descent Prov		stance	Agency	Approval							
Model	warking			@25°C	@25°C	Max.	Current	Time	Ri _{min}	R1max	UL	τυν
		(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	UL	104
SMD1210-010-60V	<i>α</i> B	60	100	0.1	0.30	0.6	0.50	0.60	0.800	15.000	\checkmark	
Ihold = Hold Curren	t. Maximum cu	irrent device	will not trip	in 25°C still a	air.							
Itrip = Trip Current.	Minimum curi	ent at which	the device v	will always tri	p in 25°C stil	l air.						
Vmax = Maximum or	erating voltag	e device car	n withstand w	vithout dama	ge at rated c	urrent (Ima	x).					
Imax = Maximum fa	max = Maximum fault current device can withstand without damage at rated voltage (Vmax).											
Pd = Power dissip	ed = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.											
Rimin/max = Minimu	Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.											
R1 _{max} = Maximum d	R1max = Maximum device resistance is measured one hour post reflow.											
CAUTION : Operation	CAUTION : Operation beyond the specified ratings may result in damage and possible arcing and flame.											

Environmental Specifications

Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202, Method 215	No change
Vibration	MIL-STD-202, Method 201	No change
Ambient operating conditions : - 40 °C to +85 °C		
Maximum surface temperature of the device in the trip	ped state is 125 °C	

of the device in the tripped state is

Agency Approvals :

AI

HF

E201504(Alpha-Top)/E319079(Sea&Land)

Regulation/Standard:



2015/863/EU EN14582

Ihold Versus Temperature

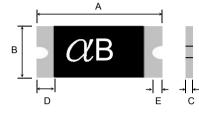
Model	Maximum ambient operating temperature (T _{mao}) vs. hold current (I _{hold})								
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
SMD1210-010-60V	0.16	0.14	0.12	0.10	0.08	0.07	0.06	0.05	0.03

SMD1210-010-60V

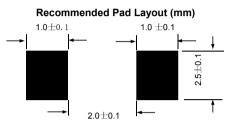
Alpha-Top (Sea&Land Alliance)

Construction And Dir	onstruction And Dimension (Unit:mm)								
Model	A		В		(С		E	
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	
SMD1210-010-60V	3.00	3.43	2.35	2.80	0.40	0.90	0.30	0.10	

Dimensions & Marking





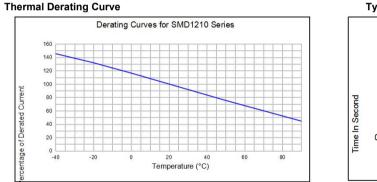


Termination Pad Characteristics

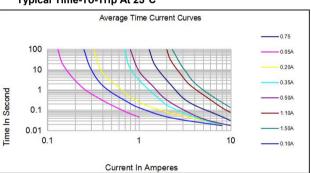
Terminal pad materials : Terminal pad solderability : Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Rework

Use standard industry practices, the removal device must be replaced with a fresh one.



Typical Time-To-Trip At 25°C



\Lambda WARNING:

· Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

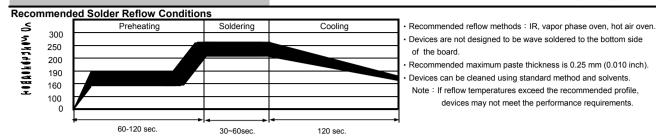
PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

• Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.

· Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

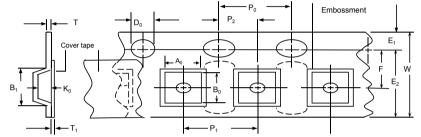
SMD1210-010-60V



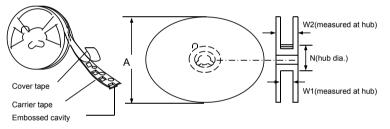
Tape And Reel Specifications (mm)

EIA Tape Component Dimensions

Governing Specifications	EIA 481-2
W	8.0 ± 0.20
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.10
A0	2.82 ± 0.10
B0	3.52± 0.10
B1max.	4.35
D0	1.5 + 0.1, -0.0
F	7.5 ± 0.05
_ <u>E1</u>	1.75 ± 0.10
E2min.	6.25
Tmax.	0.6
T1max.	0.1
К0	0.90 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	50
W1	8.4 + 1.5, -0.0
W2max.	22.4



EIA Reel Dimensions



Storage And Handling

• Storage conditions : 40°C max, 70% R.H.

· Devices may not meet specified performance

if storage conditions are exceeded.

Order Information

Order Information	1	Packaging
SMD1210	010-60V	Tape & Reel Quantity
Product name	Hold	
Size 3225 mm / 1210 inch	Current	4,500 pcs/reel
SMD : surface mount device	0.10A	

Tape & reel packaging per EIA481-1

Labeling Information

